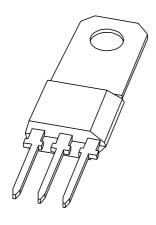
DISCRETE SEMICONDUCTORS

DATA SHEET



BD826; BD828; BD830 PNP power transistors

Product specification Supersedes data of September 1994 File under Discrete Semiconductors, SC04 1997 Jun 23





PNP power transistors

BD826; BD828; BD830

FEATURES

- High current (max. 1 A)
- Low voltage (max. 80 V).

APPLICATIONS

- General purpose
- Driver stages in hi-fi amplifiers and television circuits.

DESCRIPTION

PNP power transistor in a TO-202; SOT128B plastic package. NPN complements: BD825 and BD829.

PINNING

PIN	DESCRIPTION
1	emitter
2	collector, connected to metal part of mounting surface
3	base

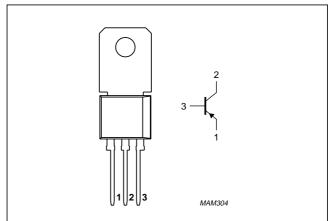


Fig.1 Simplified outline (TO-202; SOT128B) and symbol.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter				
	BD826		_	_	-45	V
	BD828		_	_	-60	V
	BD830		_	_	-100	V
V _{CEO}	collector-emitter voltage	open base				
	BD826		_	_	-45	V
	BD828		_	_	-60	V
	BD830		_	_	-80	V
I _{CM}	peak collector current		_	_	-1.5	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	_	2	W
		T _{mb} ≤ 50 °C	_	_	8	W
h _{FE}	DC current gain	$I_C = -150 \text{ mA}; V_{CE} = -2 \text{ V}$	40	_	250	
f _T	transition frequency	$I_C = -50 \text{ mA}; V_{CE} = -5 \text{ V}; f = 100 \text{ MHz}$	_	75	_	MHz

PNP power transistors

BD826; BD828; BD830

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BD826		_	-45	V
	BD828		_	-60	V
	BD830		_	-100	V
V _{CEO}	collector-emitter voltage	open base			
	BD826		_	-45	V
	BD828		_	-60	V
	BD830		_	-80	V
V _{EBO}	emitter-base voltage	open collector	_	-5	V
I _C	collector current (DC)		_	-1	Α
I _{CM}	peak collector current		_	-1.5	Α
I _{BM}	peak base current		_	-500	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	2	W
		T _{mb} ≤ 50 °C	_	8	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air	62.5	K/W
R _{th j-mb}	thermal resistance from junction to mounting base		12.5	K/W

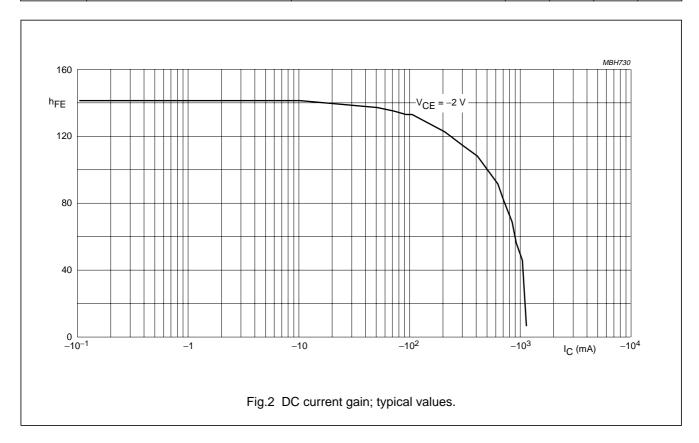
PNP power transistors

BD826; BD828; BD830

CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	I _E = 0; V _{CB} = -30 V	_	_	-100	nA
		$I_E = 0$; $V_{CB} = -30 \text{ V}$; $T_j = 125 \text{ °C}$	_	_	-10	μΑ
I _{EBO}	emitter cut-off current	$I_C = 0; V_{EB} = -5 \text{ V}$	_	_	-100	nA
h _{FE}	DC current gain	V _{CE} = −2 V; see Fig.2				
		$I_C = -5 \text{ mA}$	40	-	-	
		$I_{\rm C} = -150 \text{ mA}$	40	-	250	
		$I_{C} = -500 \text{ mA}$	25	-	_	
h _{FE}	DC current gain	$I_C = -150 \text{ mA}; V_{CE} = -2 \text{ V}; \text{ see Fig.2}$				
	BD826-10; BD828-10; BD830-10		63	-	160	
	BD826-16; BD828-16; BD830-16		100	-	250	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	_	-500	mV
V_{BE}	base-emitter voltage	$I_C = -500 \text{ mA}; V_{CE} = -2 \text{ V}$	_	_	-1	٧
f _T	transition frequency	$I_{C} = -50 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	_	75	_	MHz



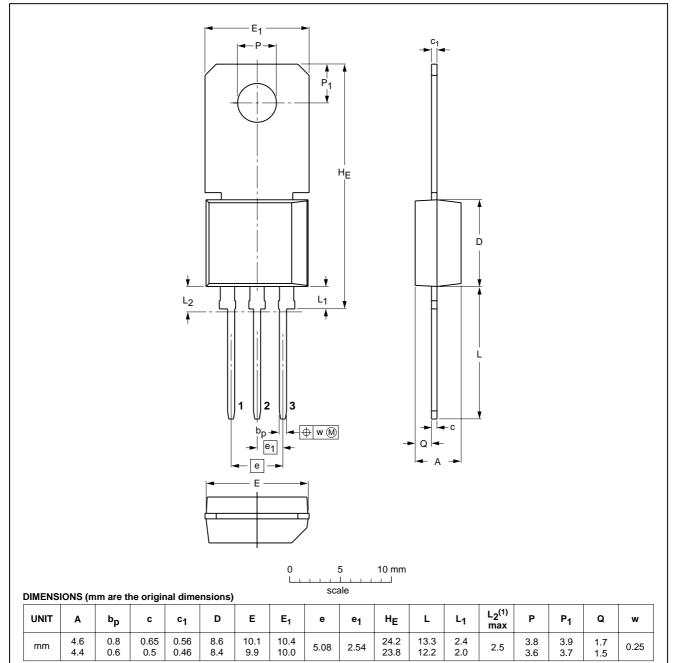
PNP power transistors

BD826; BD828; BD830

PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; with cooling fin, mountable to heatsink, 1 mounting hole; 3 leads (in-line)

SOT128B



Note

1. Plastic flash allowed within this zone

OUTLINE REFERENCES			EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT128B		TO-202				97-02-28

PNP power transistors

BD826; BD828; BD830

DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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PNP power transistors

BD826; BD828; BD830

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